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APPLICATION NO. FILING DATE		FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.	
10/730,892 12/10/2003		12/10/2003	Katherine L. Saenger	20140-00316-US	5181	
30678	7590	06/08/2005		EXAMINER		
	_	E LODGE & HUTZ	GEYER, SCOTT B			
SUITE 800 1990 M ST		V	ART UNIT	PAPER NUMBER		
WASHING	TON, DO	20036-3425	2812			
			DATE MAILED: 06/08/2005			

Please find below and/or attached an Office communication concerning this application or proceeding.

		1							
Office Action Comments		Application	No.	Applicant(s)	,				
		10/730,892		SAENGER ET AL.					
	Office Action Summary	Examiner	- , ,	Art Unit					
		Scott Geyer		2812					
Period fo	The MAILING DATE of this communication Reply	ion appears on the c	over sheet with the d	correspondence addres	SS				
THE - Exte after - If the - If NC - Failt Any	ORTENED STATUTORY PERIOD FOR MAILING DATE OF THIS COMMUNICA' nsions of time may be available under the provisions of 37 SIX (6) MONTHS from the mailing date of this communicate period for reply specified above is less than thirty (30) day of period for reply is specified above, the maximum statutor tree to reply within the set or extended period for reply will, be reply received by the Office later than three months after the patent term adjustment. See 37 CFR 1.704(b).	TION. CFR 1.136(a). In no event, ation. ys, a reply within the statutor y period will apply and will express the application.	however, may a reply be tir ry minimum of thirty (30) day xpire SIX (6) MONTHS from tion to become ABANDONE	nely filed /s will be considered timely. Ithe mailing date of this commu	unication.				
Status									
1) 又	Responsive to communication(s) filed or	n 26 April 2005.							
· · · · · · · · · · · · · · · · · · ·	•	☐ This action is non	-final.						
3)[	· <u> </u>								
,—	closed in accordance with the practice under <i>Ex parte Quayle</i> , 1935 C.D. 11, 453 O.G. 213.								
Disposit	ion of Claims								
4)⊠	Claim(s) 1-32 is/are pending in the appli	ication.							
•	4a) Of the above claim(s) <u>17-32</u> is/are withdrawn from consideration.								
5)[	Claim(s) is/are allowed.								
6)🖂	Claim(s) <u>1-5,8,10,12 and 16</u> is/are rejec	ted.							
	Claim(s) 6,7,9,11 and 13-15 is/are object								
	Claim(s) are subject to restriction		uirement.						
Applicat	ion Papers								
9)	The specification is objected to by the Ex	kaminer.							
•	The drawing(s) filed on 10 December 20		epted or b) object	ted to by the Examine	r.				
,,_	Applicant may not request that any objection			•					
	Replacement drawing sheet(s) including the				.121(d).				
11)[	The oath or declaration is objected to by	•		-					
Priority (	under 35 U.S.C. § 119								
12)	Acknowledgment is made of a claim for t	foreian priority unde	r 35 U.S.C. § 119(a	)-(d) or (f).					
•	☐ All b)☐ Some * c)☐ None of:	oreign priemy arrae	,(=	, (2) 5. (-).					
۵,	1. Certified copies of the priority doc	uments have been i	received.						
	2. Certified copies of the priority doc			ion No.					
	3. Copies of the certified copies of the				ae				
	application from the International	•							
* 5	See the attached detailed Office action fo	•	` ''						
Attachmer	ıt(s)								
_	ce of References Cited (PTO-892)	<b>4</b>	) Interview Summary	(PTO-413)					
2) Notice	ce of Draftsperson's Patent Drawing Review (PTO-		Paper No(s)/Mail D	ate					
	mation Disclosure Statement(s) (PTO-1449 or PTC er No(s)/Mail Date <u>121003</u> .		)  Notice of Informal F ) Other:	Patent Application (PTO-15	2)				

### **DETAILED ACTION**

#### Election/Restrictions

Applicant's election of claims 1-16 in the reply filed on April 26<sup>th</sup>, 2005 is acknowledged. Because applicant did not distinctly and specifically point out the supposed errors in the restriction requirement, the election has been treated as an election without traverse (MPEP § 818.03(a)).

#### Information Disclosure Statement

The references cited in the IDS document filed on December 10, 2003 (paper no. 121003) have been considered.

## Claim Rejections - 35 USC § 102

The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

(a) the invention was known or used by others in this country, or patented or described in a printed publication in this or a foreign country, before the invention thereof by the applicant for a patent.

Claims 1-5, 8, 10, 12 and 16 are rejected under 35 U.S.C. 102(a) as being anticipated by Mitsuhashi et al. (US 2003/0104706 A1).

As to **claims 1-5**, Mitsuhashi et al. teach a method of making an ultra-thin high-k gate dielectric. The high-k gate dielectric is deposited upon a substrate. The ultra-thin high-k gate dielectric is formed by thinning the deposited high-k gate dielectric material,

and the resulting thickness is between 1 to 3 nm (see paragraphs 0001 through 0069). The high-k dielectric material is made of hafnium oxide.

As to **claims 8 and 10**, Mitsuhashi et al. teach damaging a top portion of the hafnium oxide layer and then etching away the damaged portion (see figures 3A-3D).

As to **claim 12**, Mitsuhashi et al. teach the high-k dielectric material to be used as the gate dielectric. Therefore, after the gate dielectric is formed, a plurality of subsequent steps (i.e. post-thinning steps) will be performed to complete the semiconductor device.

As to **claim 16**, Mitsuhashi et al. teach annealing the high-k dielectric layer prior to the thinning process (see paragraph 0043).

## Allowable Subject Matter

Claims 6, 9, 11, 13 and 14 are objected to as being dependent upon a rejected base claim, but would be allowable if rewritten in independent form including all of the limitations of the base claim and any intervening claims. The prior art of record and to the examiner's knowledge does not teach or render obvious, at least to the skilled artisan, the instant invention regarding:

depositing an interfacial layer of metal-free dielectric material between the substrate and the high-k dielectric material, as recited in claim 6;

using physical sputtering, ion beam etching, reactive ion etching or GCIB to remove the high-k dielectric material, as recited in claim 9;

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utilizing an argon reactive ion etch as the damage treatment for the hybrid damage/wet etching treatment, as recited in claim 11;

a post-thinning treatment step of annealing in inert ambient, annealing in a reactive ambient and treating with plasma, as recited in claim 13;

adding additional material to the gate dielectric during or after the thinning step, wherein the material is form the group of material recited in claim 14.

The following references are cited as being particularly related to the applicant's invention:

Ho et al. (2004/0038538 A1);

Morisaki et al. ( Ultra-thin ( $T_{\rm eff}^{\rm inv}$  = 1.7nm Poly-Si-gated SiN/HfO<sub>2</sub>/SiON High-k Stack Dielectrics with High Thermal Stability (1050°C));

Ng et al. (Electrical Characteristics of Novel Hafnium oxide Film);

Zhan et al. (Characteristics of High Quality Hafnium Oxide gate Dielectric).

#### Conclusion

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Scott Geyer whose telephone number is (571) 272-1958. The examiner can normally be reached on weekdays, between 10:00am - 6:30pm. If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Michael Lebentritt can be reached on (571) 272-1873. The fax phone number for the organization where this application or proceeding is assigned is

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703-872-9306. Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

Scott Geyer June 1, 2005